

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2872604

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YANLING QI	12/04/2006
JASON SHERMAN	12/04/2006
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<b>Postal Code:</b>	95035
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14161439
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<b>ATTORNEY DOCKET NUMBER:</b>	P01-6952.02/CON 47415.464
<b>NAME OF SUBMITTER:</b>	THOMAS W. KELTON
<b>SIGNATURE:</b>	/Thomas W. Kelton/
<b>DATE SIGNED:</b>	05/28/2014
<b>Total Attachments: 3</b>	
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source=47415-464_Assignment-Inv-to-LSI#page3.tif	

**ASSIGNMENT OF APPLICATION**

**Docket Number: 06-1581**

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged,

**We, the undersigned,**

do hereby sell, assign, and transfer to:

LSI LOGIC CORPORATION, a corporation of Delaware, having a place of business at 1621 Barber Lane, MS D-106, Milpitas, California 95035, ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements which are disclosed in the application for United States Letters Patent,

**which has been executed by the undersigned concurrently herewith,**


and which is entitled:

**Multiple Instances of Mapping Configurations in a Storage System or Storage Appliance**


in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other application for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application; and

Agree that said Assignee may apply for and received Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements, in said Assignee, its successors, assigns and legal representatives; and Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

First named inventor


Name   
Yanling Qi

Date: 12/04/06

Witness Signature:   
Witness Printed Name: SMITHA SMITH KARA WAX  
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Second named inventor

Name

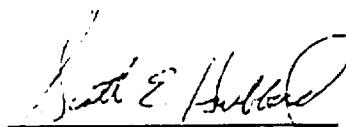


Jason Sherman

Date:

12/4/2012

Witness Signature:



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